



UNI-SEMICONDUCTOR CO., LTD

宇力半导体有限公司



AP2310 Data Sheet

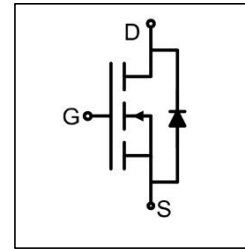
V 1.1

版权归宇力半导体有限公司

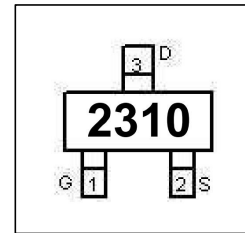
Feature

- 60V,3A
- $R_{DS(ON)} < 80 \text{ m}\Omega @ V_{GS}=10\text{V}$ TYP:55 m Ω
- $R_{DS(ON)} < 90 \text{ m}\Omega @ V_{GS}=4.5\text{V}$ TYP:70 m Ω
- Advanced Trench Technology
- Lead free product is acquired

Schematic Diagram



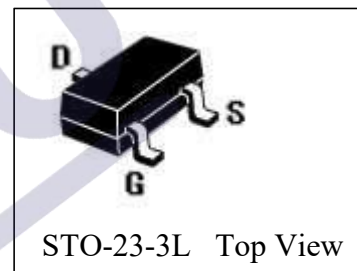
Marking and Pin Assignment



Application

- Interfacing Switching
- Load Switching
- Power management

Packages



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
2310	AP2310	Sot-23-3	7 inch	—	3000

ABSOLUTE MAXIMUM RATINGS (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current (Ta=25°C)	I_D	3	A
Continuous Drain Current (Ta =100°C)	I_D	2.3	A
Pulsed Drain Current	I_{DM}	12	A
Power Dissipation	P_D	1.68	W
Thermal Resistance from Junction to Ambient ⁽⁴⁾	$R_{\theta JA}$	90	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

MOSFET ELECTRICAL CHARACTERISTICS(T_a=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	60	—	—	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =60V, V _{GS} = 0V	—	—	1	μA
Gate-body leakage current	I _{GSS}	V _{GS} =±20V, V _{DS} = 0V	—	—	±100	nA
Gate threshold voltage ⁽³⁾	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.2	1.7	2.5	V
Drain-source on-resistance ⁽³⁾	R _{DS(on)}	V _{GS} =10V, I _D =3A	—	55	80	mΩ
		V _{GS} =4.5V, I _D =2A	—	75	90	
Dynamic characteristics						
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1MHz	—	460	—	pF
Output Capacitance	C _{oss}		—	35	—	
Reverse Transfer Capacitance	C _{rss}		—	30	—	
Switching characteristics						
Turn-on delay time	t _{d(on)}	V _{DD} =30V, I _D =1A V _{GS} =10V, R _G =3.3Ω	—	5	—	ns
Turn-on rise time	t _r		—	6	—	
Turn-off delay time	t _{d(off)}		—	17	—	
Turn-off fall time	t _f		—	3.5	—	
Total Gate Charge	Q _g	V _{DS} =30V, I _D =3A, V _{GS} =4.5V	—	6	—	nC
Gate-Source Charge	Q _{gs}		—	1.5	—	
Gate-Drain Charge	Q _{gd}		—	3.5	—	
Source-Drain Diode characteristics						
Diode Forward voltage ⁽³⁾	V _{DS}	V _{GS} =0V, I _S =3A	—	—	1.2	V
Diode Forward current ⁽⁴⁾	I _S		—	—	3.0	A

Notes:

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. Pulse Test: pulse width≤300μS, duty cycle≤2%
3. Surface Mounted on FR4 Board, t≤10 sec

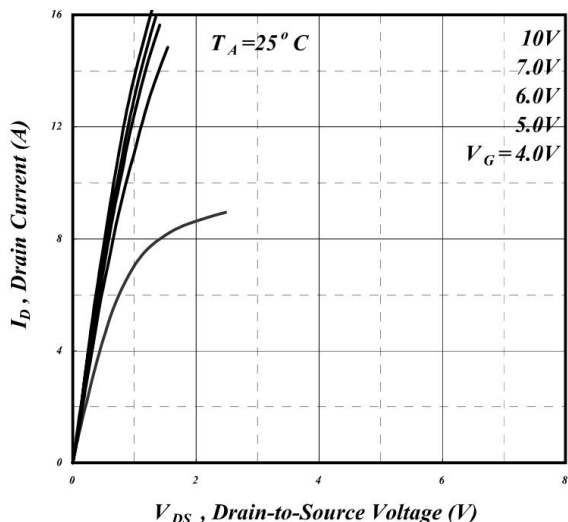


Fig 1. Typical Output Characteristics

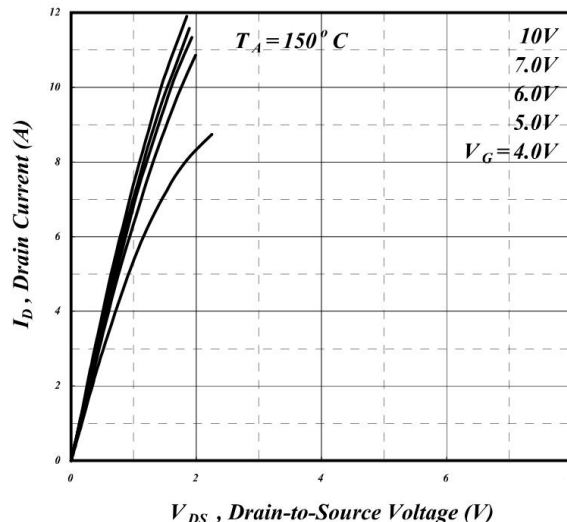


Fig 2. Typical Output Characteristics

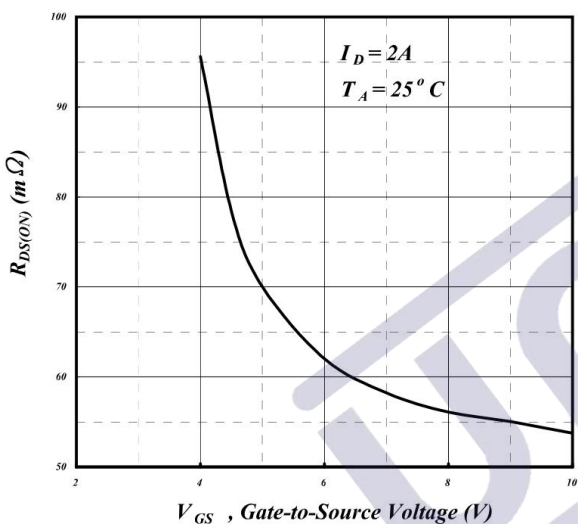


Fig 3. On-Resistance v.s. Gate Voltage

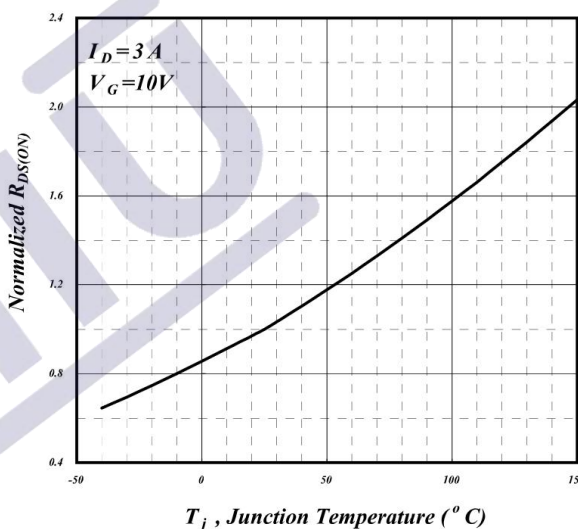


Fig 4. Normalized On-Resistance v.s. Junction Temperature

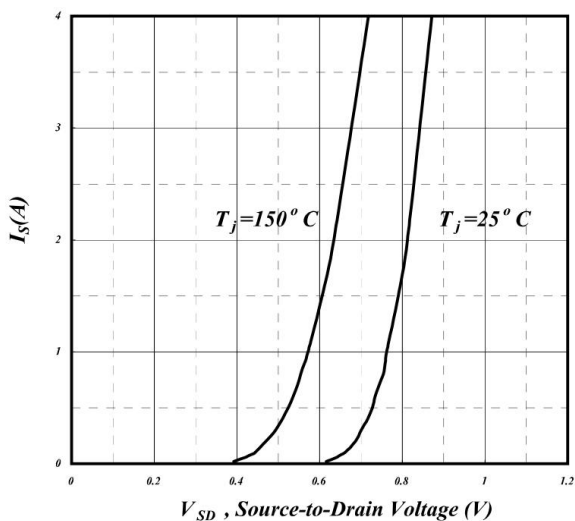


Fig 5. Forward Characteristic of Reverse Diode

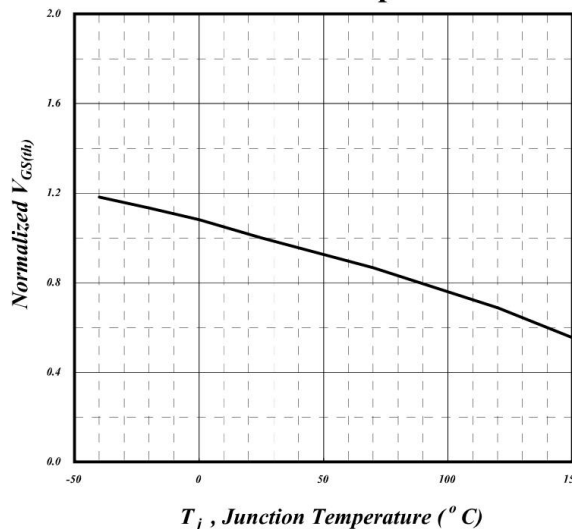


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

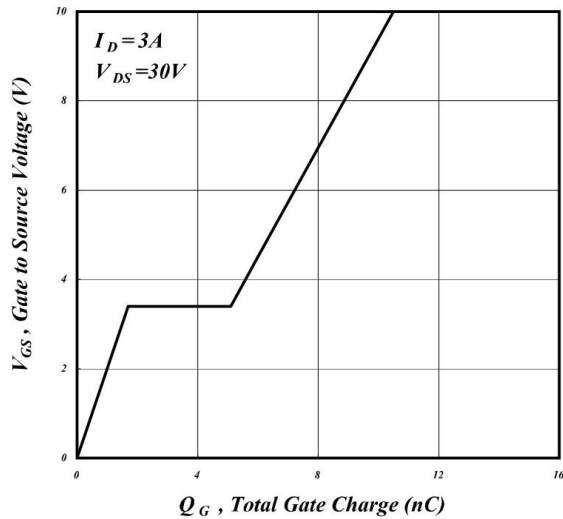


Fig 7. Gate Charge Characteristics

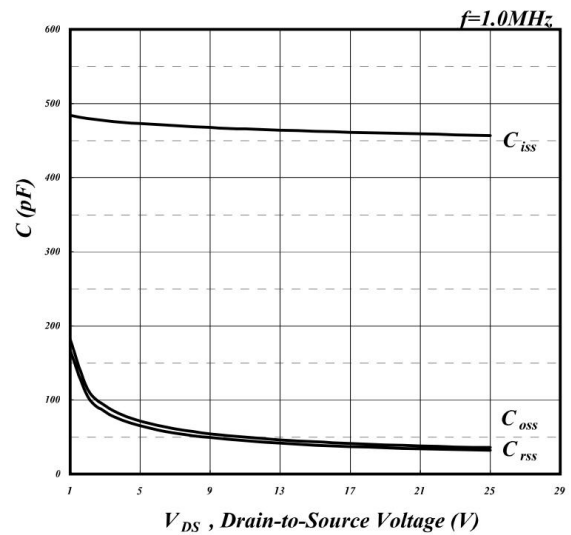


Fig 8. Typical Capacitance Characteristics

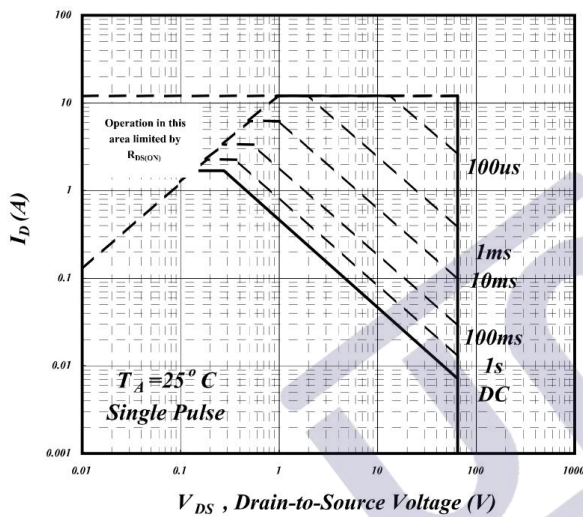


Fig 9. Maximum Safe Operating Area

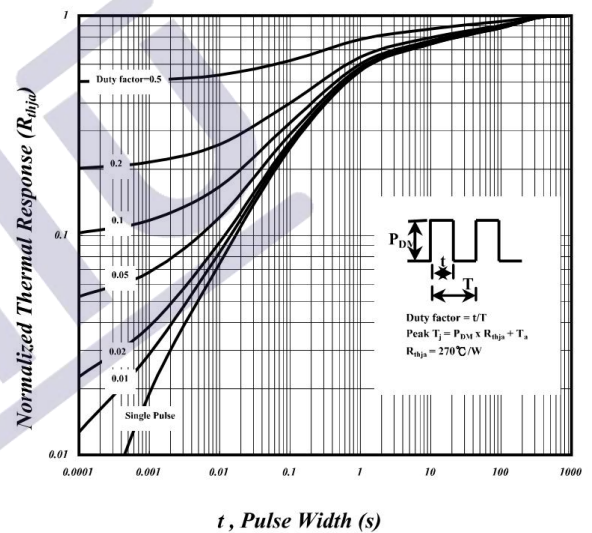


Fig 10. Effective Transient Thermal Impedance

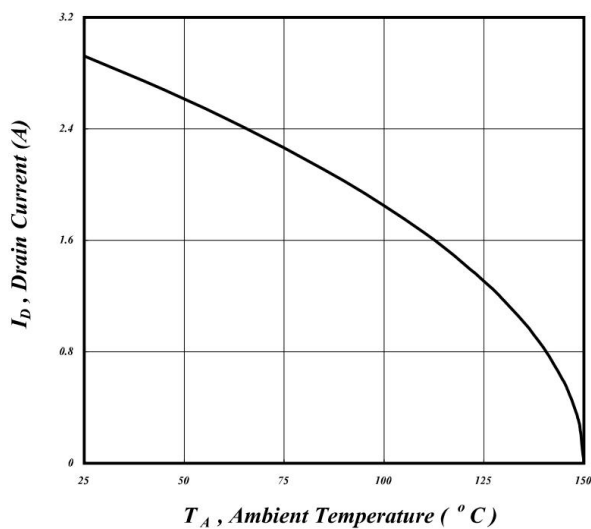


Fig 11. Maximum Continuous Drain Current v.s. Ambient Temperature

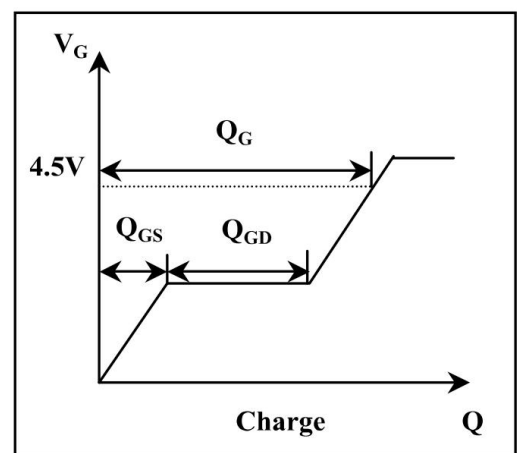


Fig 12. Gate Charge Waveform

1.版本记录

DATE	REV.	DESCRIPTION
2018/08/19	1.0	First Release
2021/08/12	1.1	Layout adjustment

2.免责声明

浙江宇力微新能源科技有限公司保留对本文档的更改和解释权力，不另行通知！客户在下单前应获取我司最新版本资料，并验证相关信息是否最新和完整。量产方案需使用方自行验证并自担所有批量风险责任。未经我司授权，该文件不得私自复制和修改。产品不断提升，以追求高品质、稳定性强、可靠性高、环保、节能、高效为目标，我司将竭诚为客户提供性价比高的系统开发方案、技术支持等更优秀的服务。

版权所有 浙江宇力微新能源科技有限公司/绍兴宇力半导体有限公司

3.联系我们

浙江宇力微新能源科技有限公司

总部地址：绍兴市越城区斗门街道袍渎路25号中节能科创园45幢4/5楼

电话：0575-85087896（研发部）

传真：0575-88125157

E-mail: htw@uni-semic.com

无锡地址：无锡市锡山区先锋中路6号中国电子（无锡）数字芯城1#综合楼503室

电话：0510-85297939

E-mail: zh@uni-semic.com

深圳地址：深圳市宝安区西乡街道南昌社区宝源路泳辉国际商务大厦410

电话：0755-84510976

E-mail: htw@uni-semic.com